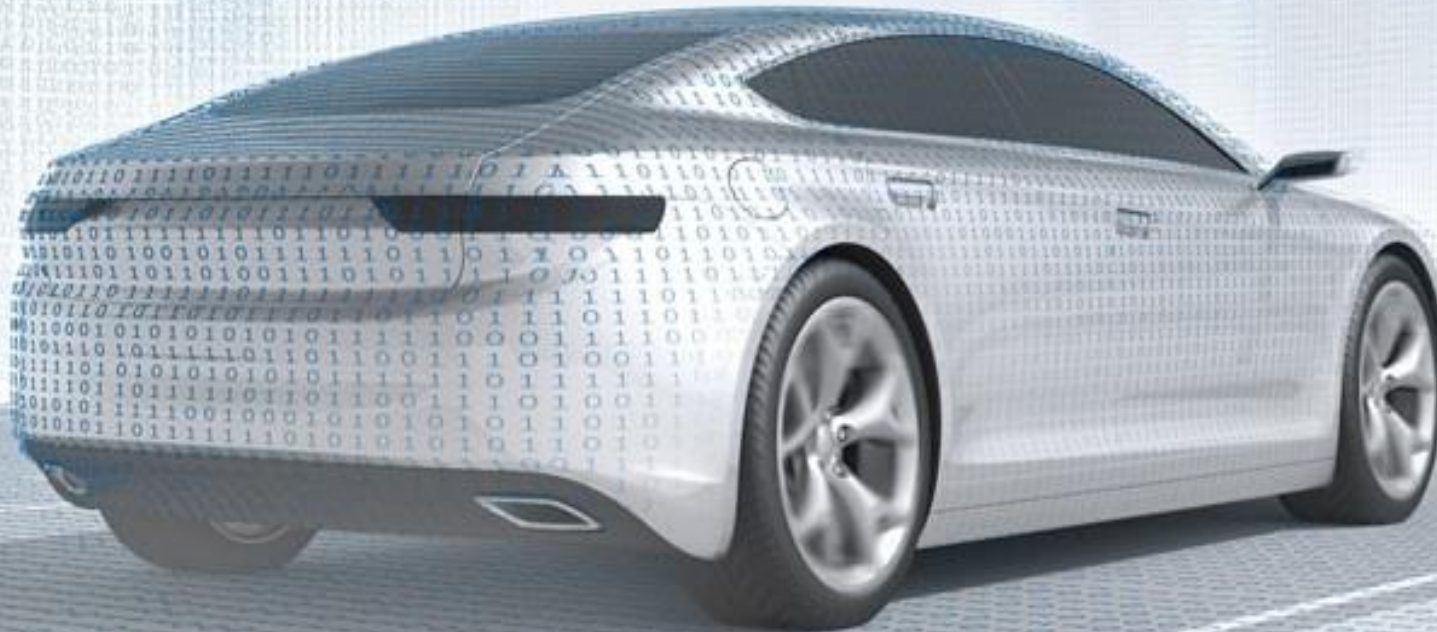


Trends of Future E/E-Architectures

How new Architectures change the Automotive Industry



Dr. Andreas Lock, Robert Bosch GmbH

Future Mobility

Electrified, Automated and Connected



costs hybrid e-motor
eBike power electronics

electrified

plug-in eScooter range
fun-to-drive battery
charging infrastructure

legislation driver assistance
emergency braking autopilot

automated

highway-pilot sensors
redundancy electric steering
valet parking

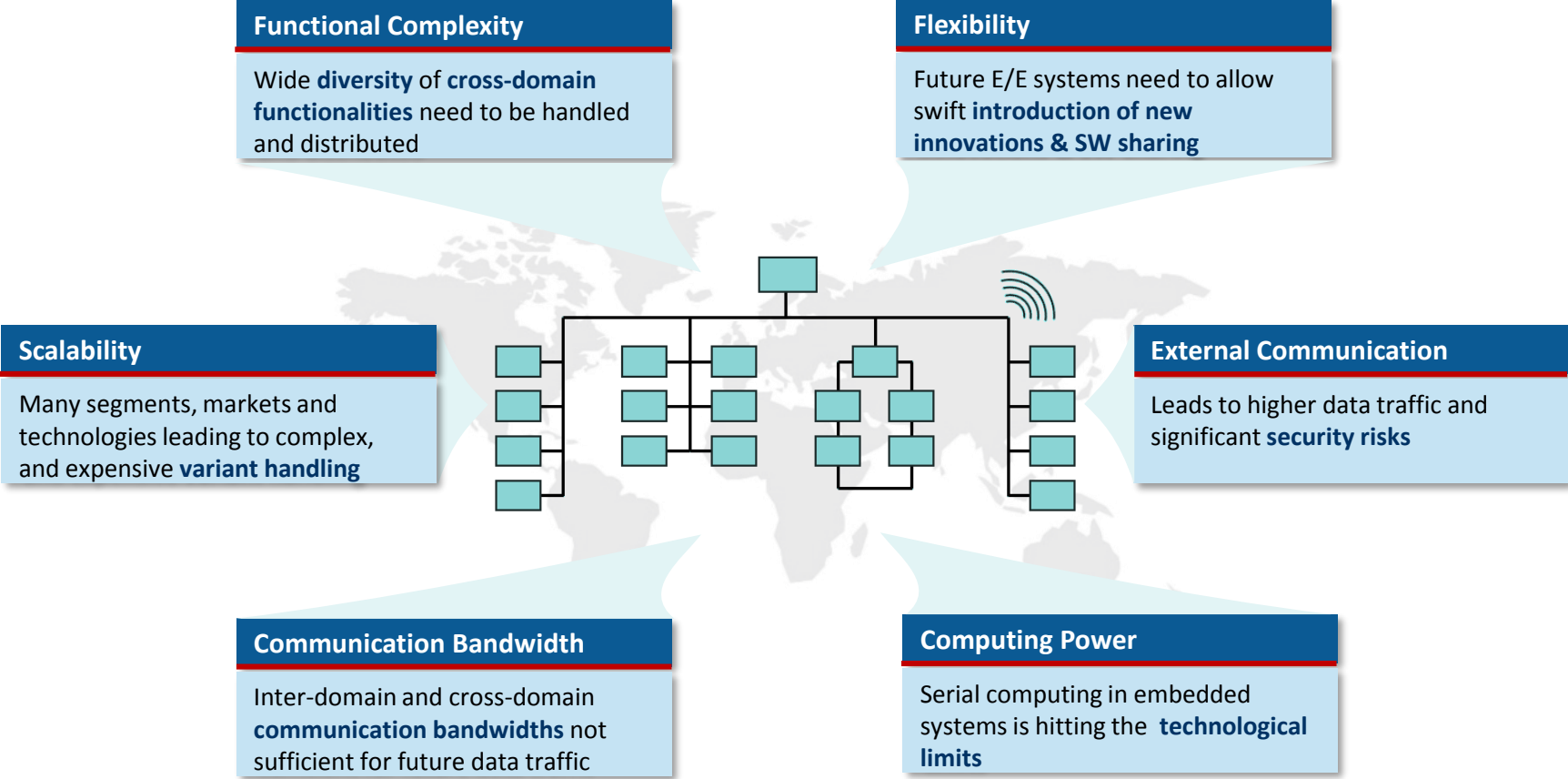
electronic horizon
smartphone integration

connected

eCall cloud
services fleet management
car2car augmented reality

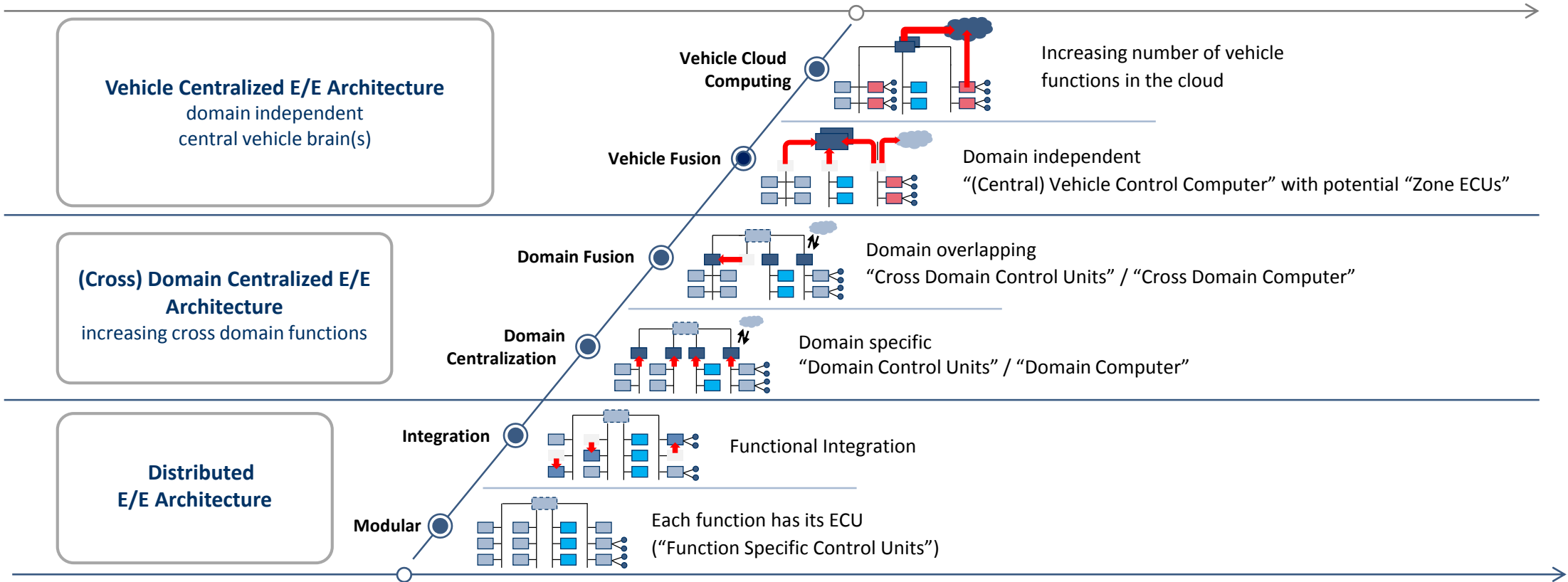
Trends of Future E/E-Architectures

Challenges and Bottlenecks



Trends of Future E/E-Architectures

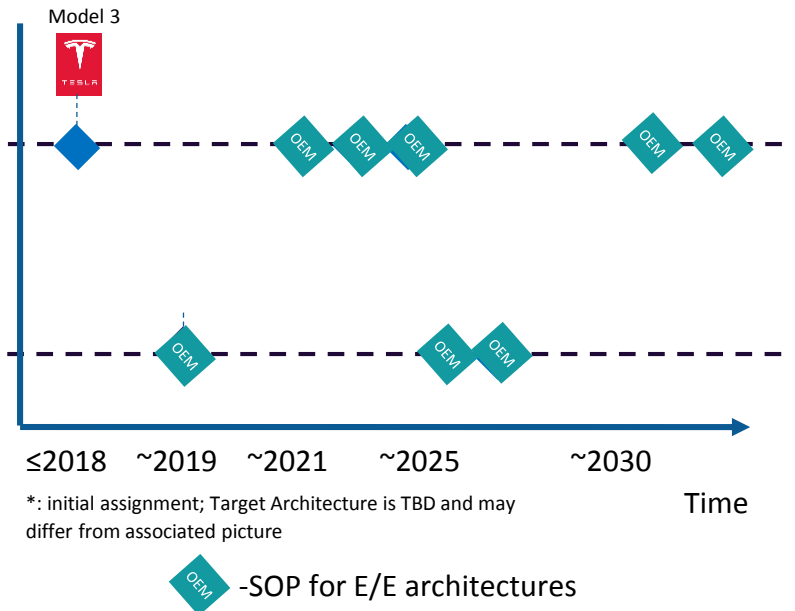
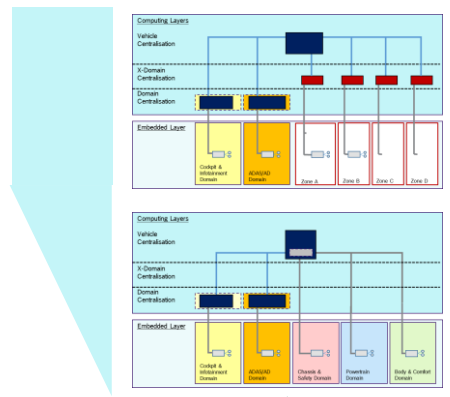
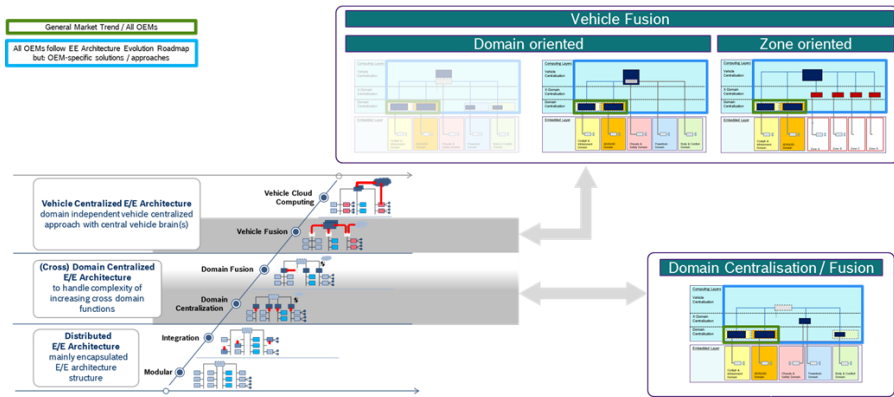
BOSCH view on E/E-Roadmap



- typ. state of the art automotive ECUs (function specific)
- Performance ECUs e.g. (Cross-)Domain Control Unit, (Cross-)Domain Computer, Vehicle Control Computer
- Optional ECUs (e.g. Central Gateway)
- Domain independent Zone ECUs
- Domain specific Zone ECUs (e.g. todays Door ECU)
- Sensors/Actuators
- ECU = Electronic Control Unit
- increasing SW amount

Functional & E/E Architecture - A Change for the Automotive Industry

Increasing Market Share of Vehicle Fusion EE Architectures



- ▶ (Cross-) Domain centralized E/E-architectures still considered as mainstream 2021
- ▶ Increasing number of major OEMs envisage introduction of vehicle centralized E/E-architectures until ~2025
- ▶ Suppliers need to adapt their product portfolio for vehicle fusion architectures (Integration Platform Vehicle Computers, Zone ECUs, Application-SW, MW, ...)

Trends of Future E/E-Architectures

High Complexity Meets Automotive Safety And Reliability

Embedded ECU

1

1st SOP: 2019

Body computer

DMIPS: 1.500
RAM: 6 MB

µC

Autosar Classic



Vehicle Computer

Supporting ARM and x86

Integration Platforms

2

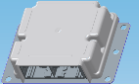
1st SOP: 2019

DASy 1.0 base

DMIPS: 3.000
RAM: 16 MB

µC

Autosar Classic



Mid

3

1st SOP: 2020



MAP ECU

PT ECU

DMIPS: 10.000
RAM*: 16 MB-1GB

µC
µP

Autosar Classic+
Adaptive
Posix OS

High

4

1st SOP: 2019

DASy 1.0 enhanced

Head Unit

DMIPS: 14.000-34.000
RAM*: 512 MB-3GB

µC
µP

Autosar Classic+
Adaptive
Posix OS




AI Computer Performance Platforms


5

SOP: 2021

DASy 2.0

DMIPS: 260.000
TOPS: 300
RAM*: 32 GB

µC
µP
HW acceleration
Autosar Adaptive
Posix OS
AI





6

SOP: 2025

DMIPS: 500.000
TOPS: >300
+ Cloud

µC
µP
HW acceleration
Autosar Adaptive
Posix OS
AI

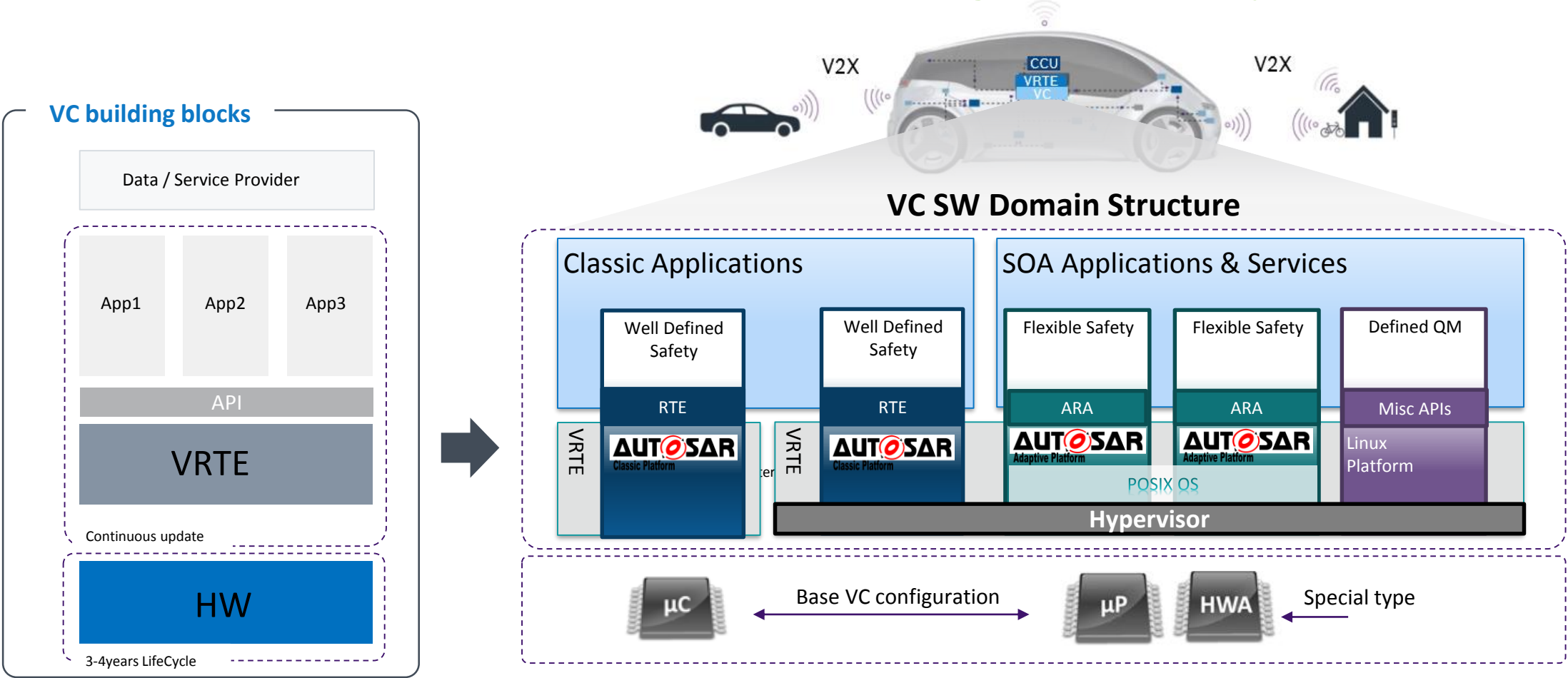



* ROM: Extension by eMMC possible



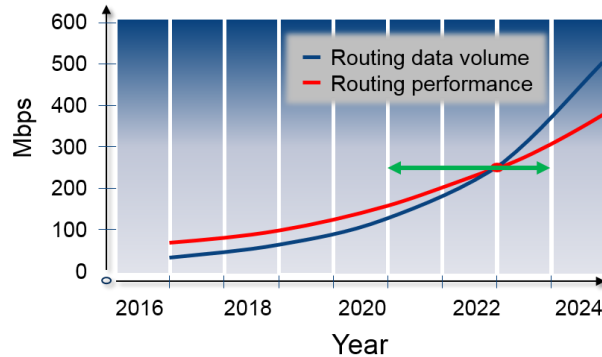
Trends of Future E/E-Architectures

Vehicle RunTime Environment: Software enabling Vehicle Computers



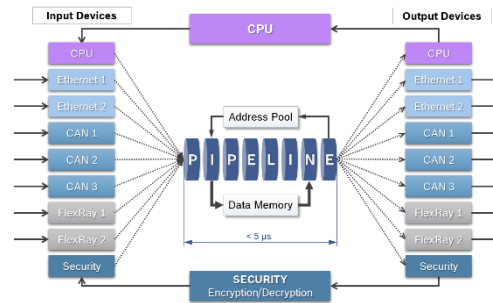
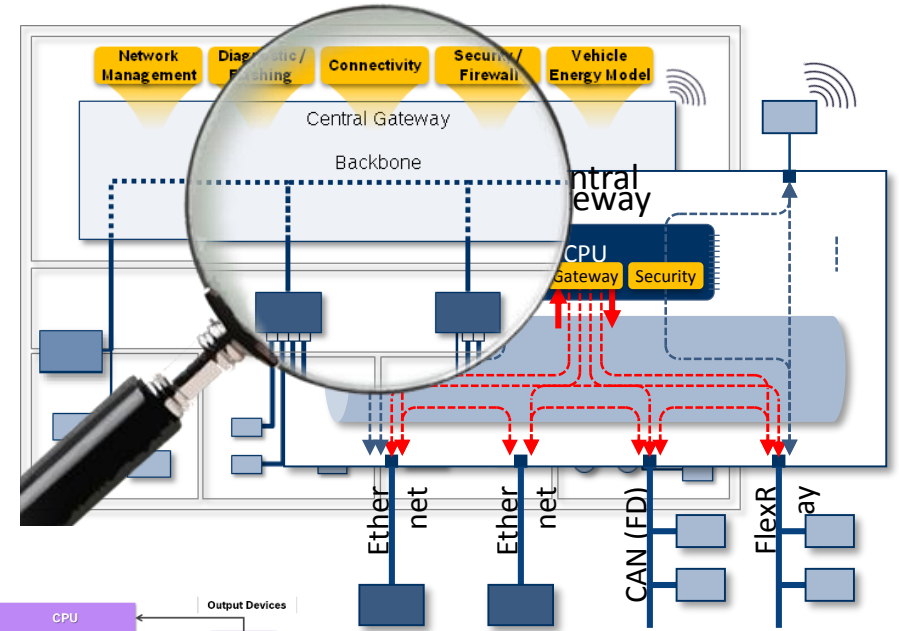
Trends of Future E/E-Architectures

Hardware Acceleration for Central Gateways



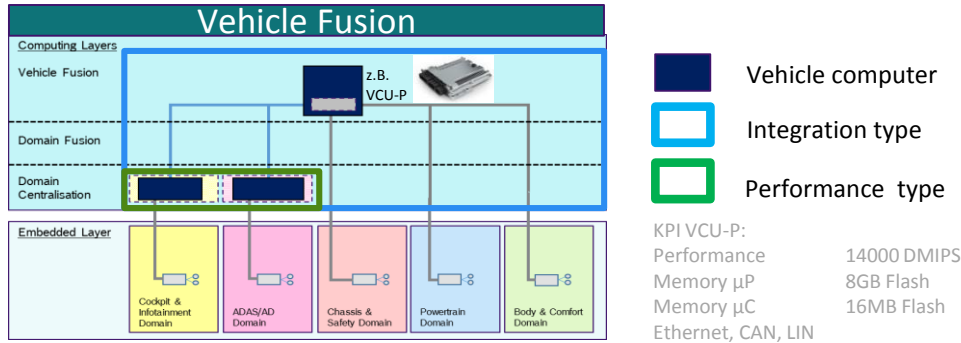
ETAS Data Engine

- “Any to any” interface, non-blocking bridging with **low latency (< 2 μs)** and **low jitter (< 1 μs)**, **high bandwidth (> 20 Gb/s)**
- Operates on OSI-Layer 2-4 (incl. TCP, UDP, CAN TP, FlexRay TP, 1722)
- **Offloads the CPU** and reduces the interrupt load
- Supports **typical automotive interfaces**: CAN-FD, FlexRay, Ethernet, PCIe
- **Configurable, flexible and extendable** by dedicated software and hardware functionalities



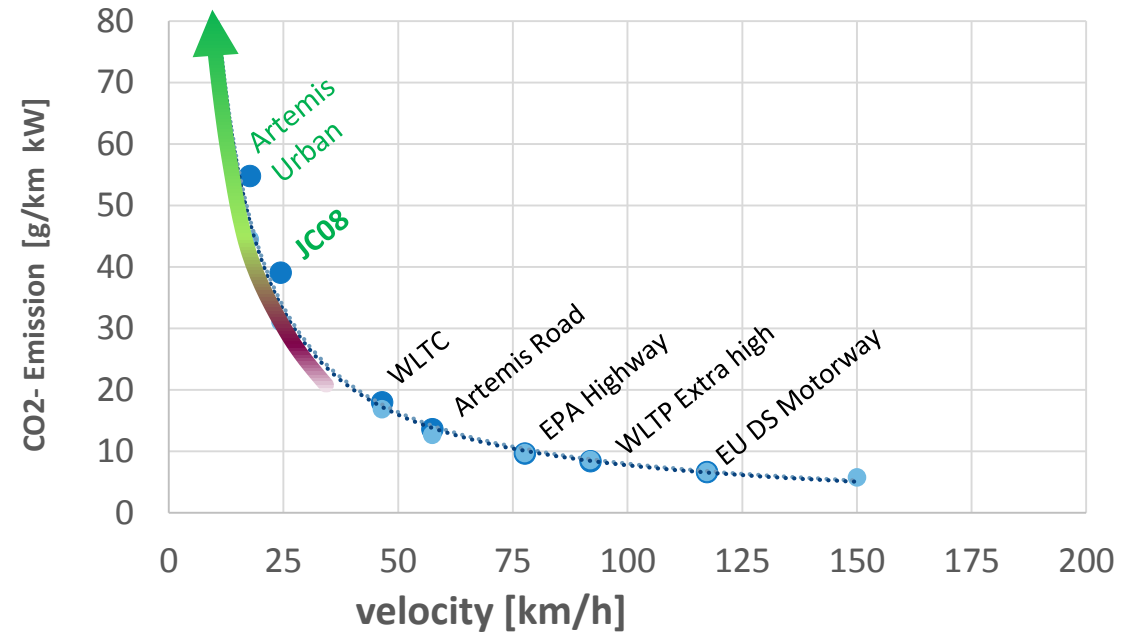
Trends of Future E/E-Architectures

Energy consumption depending on E/E-Architecture



- Growing functionality w/ higher computing & communication performance drives the electrical power demand (up to 4 kW)
- Tightening CO₂-emission (ICE) regulations and range requirements (BEV) limit the overall power consumption
- Future E/E-architectures have to become more energy efficient (e.g. HW/SW co-design, local HW-accelerators, ...)

CO₂-emission for 1 kW powernet loads



In city cycle, 1 kW Powernet-Load increases CO₂-Emission by >30 g/km (cf. Japan. Citycycle JC08)

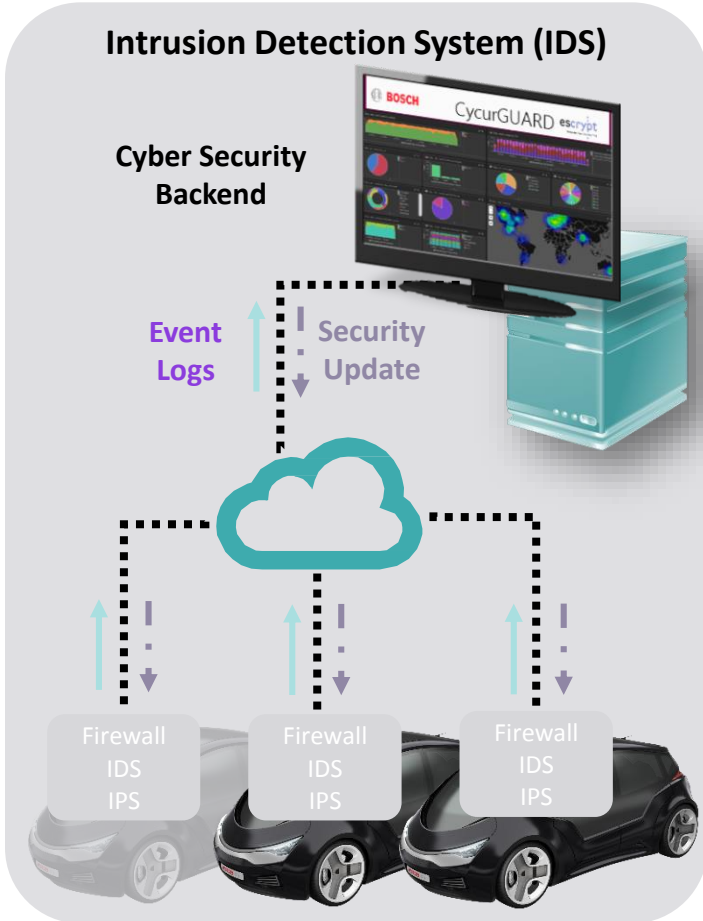
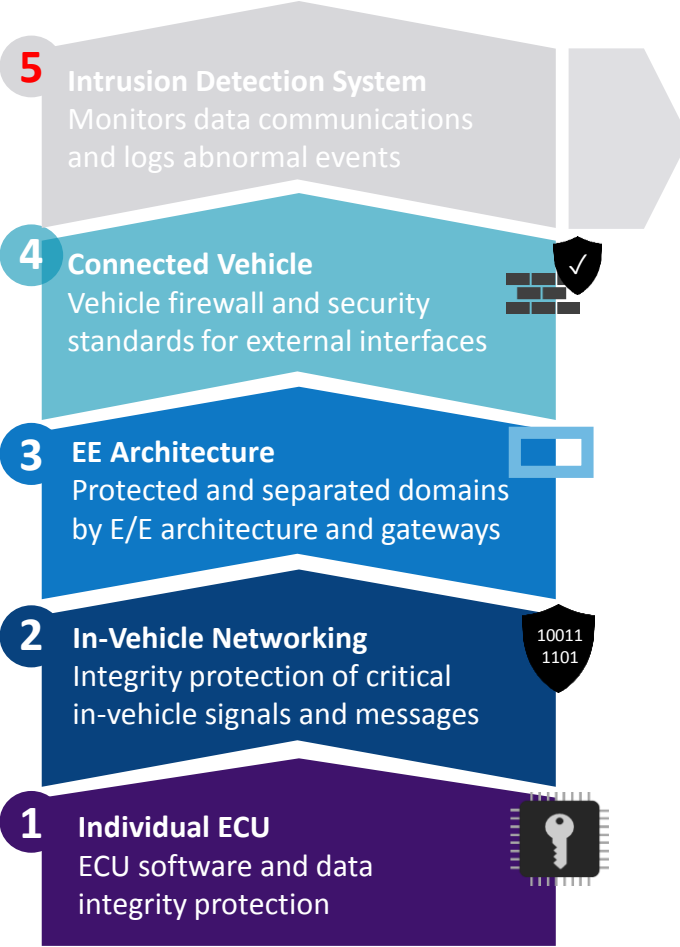
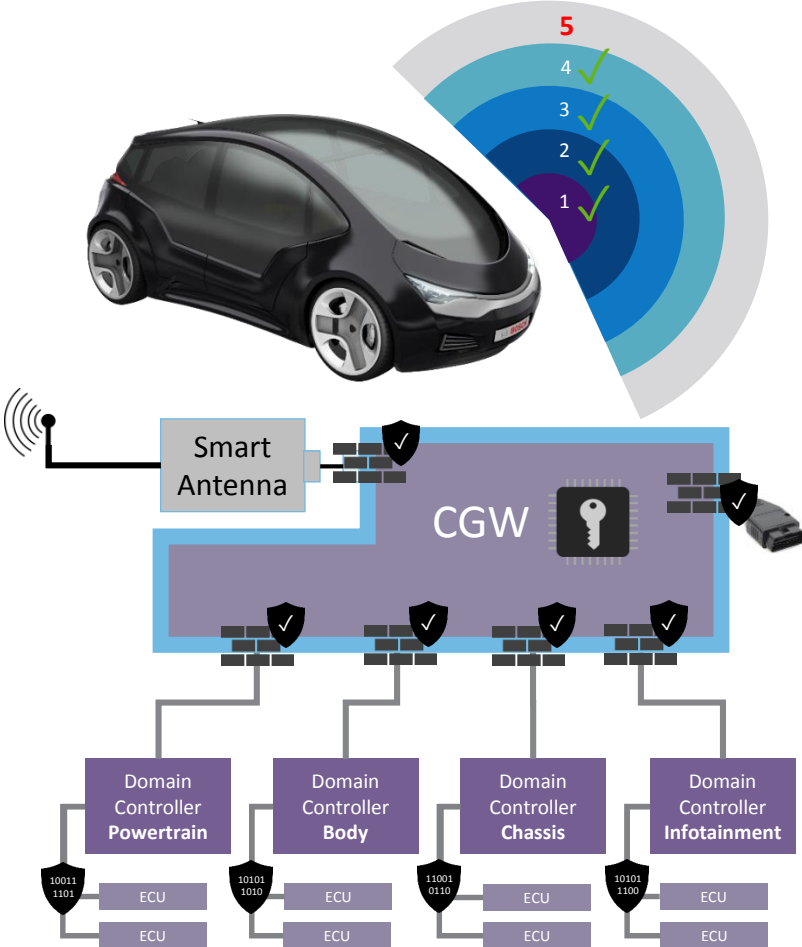
Assumptions acc. Premises vector 2.0:

CompactClass-G5.1, DI/TC 1.0L, 3zyl, 90kW, Efficiency_BRM = 0,85

vehicle weight (Veh+EM+Bat) = 1490 kg, cross section = 2.13 m², cw = 0.248, rolling radius = 306.5 mm, roll friction = 0.008

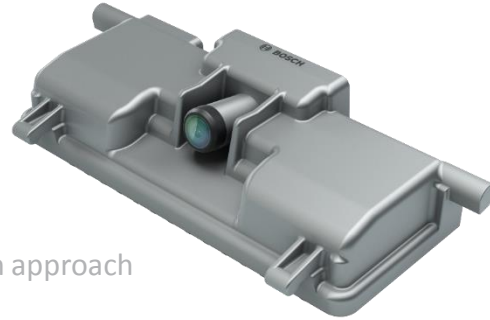
Trends of Future E/E-Architectures

Security: Holistic Approach



Trends of Future E/E-Architectures

Multi purpose camera



Safe perception through an algorithmic multi-path approach

large field of view

for detection of crossing vulnerable road users

high angular resolution

with increased range at the center

artificial intelligence

for robust perception and behavior prediction

FEATURES

- Bosch system-on-chip for ultra-high performance algorithms (flow, classifiers, disparity) with low power consumption and low thermal dissipation
- Reliable full scene understanding for increased safety using algorithmic multi-path approach
- Semantic segmentation based on deep learning and optical flow for model-free video processing
- Optical path optimization for advanced driver assistance systems

Front radar sensor plus



Impresses with improved precision, wider range and opening angles

scalable

construction kit

immune

to adverse weather conditions

high performance

with advanced Bosch chirp sequence modulation scheme

FEATURES

- NCAP (AEB City, AEB Inter-Urban, AEB Vulnerable Road Users)
- Improved comfort for Adaptive cruise control (ACC) up to 210 km/h
- Partially automated driving (supports traffic jam assist / pilot, highway assist)
- Multi-object tracking
- Handles complex traffic situations

Trends of Future E/E-Architectures

Summary

- ▶ Automated, Connected , Electrified & Shared (ACES) drive ...
 - ▶ ... the tremendous growth of cross domain functions and system characteristics like functional safety, cyber security and energy management and hence system complexity
 - ▶ ... the functional centralization and introduction of vehicle integration platforms and zone controllers
- ▶ In future, vehicle functions can / will be re-allocated to vehicle computers according to changed requirements and constitute the separation of SW from HW
- ▶ New architectures require high computational power and communication bandwidth but need simultaneously high power efficiency leading to the use of HWA for selected applications
- ▶ Higher AD level (> SAE L3) need large numbers of number of sensors with technological diversity

Vehicles become the internet devices with the most complex software and highest computational power

Thank you!

The Revolution of
Automotive Architectures
has started

8



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